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(54) Title: ADDITION-CURABLE ORGANOPOLYSILOXANE RESIN COMPOSITION

(57) Abstract: Addition-curable organopolysiloxane resin composition comprising an organopolysiloxane resin that contains at least alkenyl, hydroxyl, and phenyl directly bonded to silicon of which at least 30 mole% is phenyl; an organohydrogenoligosiloxane or organohydrogenopolysiloxane that contains at least phenyl directly bonded to silicon of which at least 20 mole% is phenyl; and an addition reaction-curing catalyst.



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